

**JUN 27 2007**

S3-02P11786 - Application No.: 10/531,250  
Responsive to Notice of Non-Compliant Amdt dated: 06/19/2007  
Correction dated: 06/27/2007

**ABSTRACT OF THE DISCLOSURE**

The invention relates to a method for producing a housing, wherein the base body of the housing (10) is initially separated from a hollow profile and a printed circuit board (1) is subsequently inserted into the base body of the housing (10). The base body of the housing (10) is then closed laterally with the aid of covering elements (6).